ECX-SFP01RJ-SR-GN-03

1000Base-T Copper SFP Transceiver

Product Features

- > Up to 1.25Gb/s bi-directional data links
- Hot-pluggable SFP footprint
- Extended case temperature range
- Fully metallic enclosure for low EMI
- Low power dissipation
- Compact RJ-45 connector assembly
- > Access to physical layer IC via 2-wire serial bus
- > 1000 BASE-T operation in host systems with SERDES interface
- > 10/100/1000Mbps compliant in host systems with SGMII interface

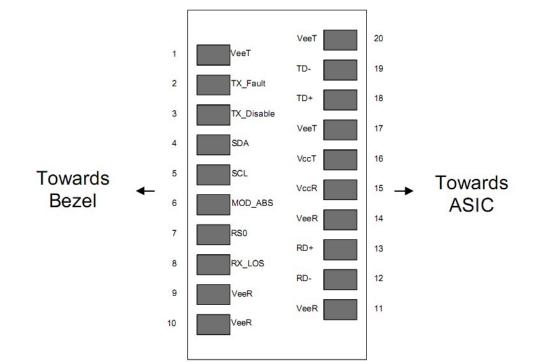
Applications

> 1.25 Gigabit Ethernet over Cat 5 cable

Description

ECX-SFP01RJ-SR-GN-03 Copper Small Form Pluggable (SFP) transceivers are high performance, cost effective module compliant with the Gigabit Ethernet and 1000BASE-T standards as specified in IEEE 802. 3-2002 and IEEE 802.3ab, which supporting 1000Mbps data- rate up to 100 meters reach over unshielded twisted-pair category 5 cables. The module supports1000 Mbps full duplex data-links with 5-level Pulse Amplitude Modulation (PAM) signals. All four pairs in the cable are used with symbol rate at 250Mbps on each pair. The module provides standard serial ID information compliant with SFP MSA, which can be accessed with address of A0h via the 2wire serial EEPROM protocol. The physical IC can also be accessed via 2wire serial bus at address A0h.

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Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
1	VEET	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Not supported
3	TX DISABLE	Transmitter Disable	3	
4	SDA	SDA Serial Data Signal	3	
5	SCL	SCL Serial Clock Signal	3	
6	MOD_ABS	Module Absent. Grounded within the module	3	
7	RS0	Not Connected	3	
8	LOS	Loss of Signal	3	Not supported
9	V _{EER}	Receiver ground	1	
10	V _{EER}	Receiver ground	1	
11	V _{EER}	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	
13	RD+	Received Data Out	3	

14	V _{EER}	Receiver ground	1	
15	V _{CCR}	Receiver Power Supply	2	
16	V _{CCT}	Transmitter Power Supply	2	
17	VEET	Transmitter Ground	1	
18	TD+	Transmit Data In	3	
19	TD-	Inv. Transmit Data In	3	
20	VEET	Transmitter Ground	1	

+3.3V Volt Electrical Power Interface

ECX-SFP01RJ-SR-GN-03 has an input voltage range of +3.3V +/- 5%. The 3.3V maximum voltage

is not allowed for continuous operation.

+3.3V volt Electrical Power Interface										
Parameter Symbol Min Typ Max Units Notes/Conditions										
Supply Current	ls		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below				
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND				
Maximum Voltage	Vmax			4	V					
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below				

Caution: Power consumption and surge current are higher than the specified values in the GBIC MSA

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to Host_Vcc.

 Table 2. Low-speed signals, electronic characteristics

 Low-Speed Signals, Electronic Characteristics

Parameter Symbol		Min	Мах	Units	Notes/Conditions					
GBIC Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
GBIC Output HIGH	VOH	host_Vcc - 0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
GBIC Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at GBIC side of connector					
GBIC Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at GBIC side of connector					

High-Speed Electrical Interface

All high-speed signals are AC-coupled internally. Table 3. High-speed electrical interface, transmission line-GBIC

High-Speed Electrical Interface Transmission Line-GBIC									
Parameter Symbol Min Typ Max Units Notes/Conditions									
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3			
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz			
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz			

High-speed electrical interface, host-GBIC

Table 4. High-speed electrical interface, host-GBIC

High-Speed Electrical Interface, Host-GBIC											
ParameterSymbolMinTypMaxUnitsNotes/Conditions											
Single ended data input swing	Vinsing	250		1200	mV	Single ended					
Single ended data output swing	Voutsing	350		800	mV	Single ended					
Rise/Fall Time	Tr,Tf		175		psec	20%-80%					
Tx Input Impedance	Zin		50		Ohm	Single ended					
Rx Output Impedance	Zout		50		Ohm	Single ended					

General Specifications

Table 5. General specifications

General										
Parameter	Symbol	Min	Тур	Мах	Units	Notes/Conditions				
Data Rate	BR	10		1,000	Mb/sec	IEEE 802.3 compatible. See Notes 2 through 4 below				
Cable Length	L			100	m	Category 5 UTP. BER <10-12				
Notes:	lotes:									

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- 1. Clock tolerance is +/- 50 ppm
- 2. By default, the module is a full duplex device in preferred master mode
- 3. Automatic crossover detection is enabled. External crossover cable is not required
- 4. 1000 BASE-T operation requires the host system to have an SGMII interface with no clocks, and the module PHY to be configured per Application Note AN-2036. With a SERDES that does not support SGMII, the module will operate at 1000BASE-T only.

Environmental Specifications

Table 6. Environmental specifications

Environmental Specifications										
Parameter Symbol Min Typ Max Units Notes/Conditions										
Operating Temperature	Тор	0		70	°C	Case temperature				
		-40		85		Case temperature				
Storage Temperature	Tsto	-40		85	°C	Ambient temperature				

References

1. Gigabit Interface Converter (GBIC) Transceiver Multi-Source Agreement (MSA),

2. IEEE Std 802.3, 2002 Edition. IEEE Standards Department, 2002.

3. "AT24C01A/02/04/08/16 2-Wire Serial EEPROM", Atmel Corporation.

4. "Alaska Ultra 88E1111 Integrated 10/100/1000 Gigabit Ethernet Transceiver", Marvell Corporation.

Mechanical Specifications

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